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2823

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Huang, et al.

Serial No.: 09/270,039

Confirmation No.: 1949

Filed: March 16, 1999

For: In Situ Deposition of a Low K
Dielectric Layer, Barrier Etch
Stop Layer and Anti-Reflective
Coating for Damascene
Application

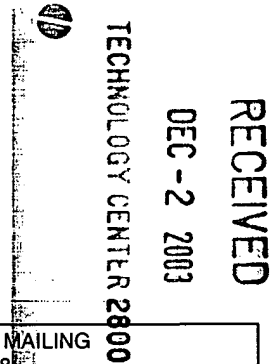
MAIL STOP NON-FEE AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

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Group Art Unit: 2823

Examiner: George R. Fourson, III



CERTIFICATE OF MAILING 37 CFR 1.8	
I hereby certify that this correspondence is being deposited on <u>11/19</u> , 2003 with the United States Postal Service as First Class Mail in an envelope addressed to: Mail Stop Non- Fee Amendment Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.	
<u>11/19/03</u> Date	<u>[Signature]</u> Signature

RESPONSE TO OFFICE ACTION DATED AUGUST 27, 2003

In response to the Office Action dated August 27, 2003, having a shortened statutory period for response set to expire on November 27, 2003, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicant believes that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/2966.X3/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

The Pending Claims are listed on page 2 of this paper. **Remarks/Arguments** begin on page 5 of this paper.